ADHESION AND PERMEABILITY OF POLYIMIDE-CLAY NANOCOMPOSITE AS PROTECTIVE COATING FOR MICROELECTRONIC GAS SENSOR

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อรสา ขยันการ : คุณสมบัติการยึดติดและการแพร่ผ่านของวัสคุลูกผสมระหว่างพอลิ อิมมิค-ดินสำหรับเคลือบปกป้องตัวตรวจวัดก๊าซแบบอิเลคทรอนิกส์ (Adhesion and Permeability of Polyimide-Clay Nanocomposite as Protective Coating for Microelectronic Gas Sensor) อ. ที่ปรึกษา : ศ. โจฮันเนส ดับบลิว ชวางค์ (Prof. Johannes W. Schwank) และ คร. รัตนวรรณ มกรพันธุ์ 61 หน้า ISBN 974-334-185-4

สารลูกผสมระหว่างพอลิอิมมิดและดินสามารถเตรียมจากสารละลายกรดพอลิเอมิค ชนิด BPDA-PDA และดินที่ผ่านการปรับสภาพโดยใช้โดเดกซิลเอมีนแล้ว การตรวจสอบการเข้า ไปอยู่ของสารปรับสภาพในโครงสร้างของดินทำโดยเทกนิค FTIR, TGA, WAXD และ AAS จากนั้นเตรียมฟิล์มพอลิอิมมิดและฟิล์มของสารลูกผสมระหว่างพอลิอิมมิดและดินและนำฟิล์มที่ ได้ทั้งหมดไปตรวจสอบกุณสมบัติการแพร่ผ่านของก๊าซ ค่าความด้านทานไฟฟ้า และการยึดติด ของแผ่นฟิล์มกับผิวของแผ่นซิลิคอน ผลการศึกษาการแพร่ผ่านของก๊าซพบว่า ปริมาณของดินที่ เติมลงในวัสดุลูกผสมเพียงแค่ร้อยละ 3 โดยน้ำหนัก ทำให้ค่าการแพร่ผ่านของก๊าซออกซิเจนลด ลงมากกว่าครึ่งหนึ่งของค่าการแพร่ผ่านของก๊าซออกซิเจนที่ได้จากฟิล์มพอลิอิมมิด นอกจากนั้น วัสดุลูกผสมนี้ยังมีค่าความด้านทานไฟฟ้าเพิ่มขึ้น ทั้งนี้เนื่องจากการขัดขวางการเกิดร่างแหการ นำไฟฟ้าโดยชั้นซิลิเกตในดิน และที่สำคัญคือค่าการยึดติดของแผ่นฟิล์มกับผิวของแผ่นซิลิคอน เพิ่มขึ้นเมื่อปริมาณของคินที่เติมลงในวัสดุลูกผสมเพิ่มมากขึ้น

ABSTRACT

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Permeability

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Polyimide-clay (PI-clay) nanocomposite was prepared from solution of poly(amic acid), precursor of 2,2-bis[4-(3,4-dicarboxyphenoxy)phenyl] propane dianhydride and p-phenylenediamine, and dodecylaminemontmorillonite. Fourier transform infrared spectroscopy, thermogravimetric analysis, X-ray diffraction, and atomic absorption spectroscopy were used to verify the incorporation of modifying agents into the structure of clay and intercalation of modified clay into the polyimide matrix. Both PI and PI-clay films were subsequently prepared by means of solution casting techniques. Gas permeability, resistivity, and adhesion properties were determined. In the case of gas permeability, only 3 wt% addition of clay brought permeability of O₂ gas to values less than half of that of unfilled polyimide. Furthermore, this hybrid showed an improvement in electrical resistivity due to the prevention of electrical tree growth by clay particles. More importantly, adhesion between the films and silicon was increased with increasing clay content.

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